

G493-ZB3 (rev. AAP1)

HPC/AI Server - AMD EPYC™ 9004 - 4U DP 8 x PCIe Gen5 GPUs

Al # Al Training # Al Inference # Visual Computing # HPC

NVIDIA-Certified Systems™ - Data Center Servers

Supports up to 8 x Dual slot Gen5 GPUs

Dual AMD EPYC[™] 9004 Series Processors (with AMD 3D V-Cache[™] Technology)

12-Channel RDIMM DDR5, 48 x DIMMs

Dual ROM Architecture

2 x 1Gb/s LAN ports via Intel 1350-AM2

12 x 2.5" Gen5 NVMe/SATA/SAS-4 hot-swappable bays

2 x M.2 slots with PCIe Gen3 x4 interface

8 x FHFL PCIe Gen5 x16 slots for GPUs

8 x LP PCle Gen5 x16 slots

2 v I D DCIa CanE v16 class on the front side





SPECIFICATIONS

Dimensions (WxHxD. mm)

448 x 176 x 880

Motherboard

M7B3-G41

CPU

AMD EPYC™ 9004 Series Processors AMD EPYC™ 9004 Series Processors with AMD 3D V-Cache™

Technology
Dual processor, 5nm technology

*Up to 128 cores, 256 threads per processor cTDP up to 300W at ambient 35°C

*cTDP supported up to 400W under limited thermal conditions. Please contact technical support for more details.

Note: If only 1 CPU is installed, some PCIe or memory functions

2 x LGA 6096

System on Chip

48 x DIMM slots DDR5 memory supported only 12-Channel memory architecture RDIMM up to 96GB supported

3DS RDIMM up to 256GB supported Memory speed: Up to 4800 MT/s (1DPC), 3600 MT/s (2DPC)

LAN

Front side: 2 x 1Gb/s LAN ports (1 x Intel [®] 1350-AM2) Support NCSI function

1 x 10/100/1000 Mbps Management LAN

Integrated in Aspeed [®] AST2600 2D Video Graphic Adapter with PCIe bus interface 1920x1200@60Hz 32bpp

12 x 2.5" Gen5 NVMe/SATA/SAS-4* hot-swappable bays - (6 x NVMe from CPU_0, 6 x NVMe from CPU_1)

SAS

Require SAS add-in cards

RAID

Require RAID add-in cards

Expansion Slots

- 4 x PCIe x16 (Gen5 x16) FHFL slots, from PEX89144 0, for GPUs 4 x PCIe x16 (Gen5 x16) FHFL slots, from PEX89144_1, for GPUs
- 4 x PCle x16 (Gen5 x16) low-profile slots, from PEX89144_0 4 x PCle x16 (Gen5 x16) low-profile slots, from PEX89144_1
- 1 x PCIe x16 (Gen5 x16) low-profile slot on the front side, from
- CPU_0 1 x PCIe x16 (Gen5 x16) low-profile slot on the front side, from CPU_1
- System is validated for population with a uniform GPU model.
 Support is not provided for mixed GPU populations.

- M-key PCle Gen3 x4. from CPU 0
- Supports 2280/22110 cards

- M-key PCle Gen3 x4, from CPU_1 Supports 2280/22110 cards

1 x TPM header

- 2 x USB 3.2 Gen1
- 1 x VGA 2 x RJ45
- 1 x MLAN
- 1 x Power button with LED 1 x ID button with LED 1 x NMI button
- 1 x Reset button
- 1 x Storage activity LED 1 x System status LED

Rear I/O

N/A

Backplane Board

Speed and bandwidth PCIe Gen5 x4 or SATA 6Gb/s or SAS-4 24Gb/s

1 x TPM header with SPI interface Optional TPM2.0 kit: CTM010

Power Supply

3+1 3000W 80 PLUS Titanium redundant power supplies

- AC Input: 100-127V~/ 14.5A, 50/60Hz
- 200-220V~/ 16A, 50/60Hz 220-240V~/ 16A, 50/60Hz

DC Input: (Only for China) - 240Vdc/ 16A

DC Output:

- Max 1097.4W/ 100-127V~ +12.2V/ 87A +12Vsb/ 3A

- Max 2598W/ 200-220V~ +12.2V/ 210A

- +12Vsb/ 3A Max 3037.2W/ 220-240V~ or 240Vdc Input
- +12Vsb/3A

Note: The system power supply requires C19 power cord.

System Management

Aspeed AST2600 management controller GIGABYTE Management Console (AMI MegaRAC SP-X) web interface

Dashboard HTML5 KVM Sensor Monitor (Voltage, RPM, Temperature, CPU Status ...etc.) Sensor Reading History Data FRU Information SEL Log in Linear Storage / Circular Storage Policy Hardware Inventory Fan Profile System Firewall Power Consumption Power Consumption Power Control Adyanced power capping Power Control Advanced power capping LDAP / AD / RADIUS Support Backup & Restore Configuration Remote BIOS/BMC/CPLD Update Event Log Filter User Management Media Redirection Settings PAM Order Settings SSL Settings SMTP Settings

OS Compatibility

Please refer to OS compatibility table in support page

Additional certifications: VMware ESXi 8.0

12 x 60x60x38mm (23,000rpm)*

*Two fans share a single power connector.

Operating Properties

Operating temperature: 10°C to 35°C
Operating humidity: 8%-80% (non-condensing)
Non-operating temperature: -40°C to 60°C
Non-operating humidity: 20%-95% (non-condensing)

Packaging Dimensions

1200 x 800 x 444 mm w/ pallet

Packaging Content

- 1 x G493-ZB3-AAP1 2 x CPU fansinks 8 x GPU power cables (12VHPWR to 12VHPWR, 150mm) 1 x L-shape Rail kit

- Barebone package: 6NG493ZB3DR000AAP1* - Motherboard: 9MZB3G41UR-000

Part Numbers

- Motherboard: 9MXB3G41UR-000
 L-Ishape Rail kit: 25H82-A96100-K0R
 CPU fansink: 25ST0-0Z6023-CTR/25ST0-0Z6024-C1R
 Bickplane board CBP10C2: 9CBP10C2NR-00
 Fan module: 25ST2-663823-F1R
 PCle bridge board CPB6000: 9CPBG000NR-00
 PCle switch board CPB4AG0: 9CPB4AG0NR-00
 G-SCM board CPCG110: 9CDCG110UR-00
 GPU power cable (12VHPWR, 150mm): 25CRI-150004-Y4R
 Power supply: 25EP0-23000C-D0S

Optional parts:

- C19 power cord 125V/15A (US): 25CP1-018000-Q0R C19 power cord 250V/16A (EU): 25CP3-01830H-Q0R C19 power cord 125V/15A (JP): 25CPA-01830B-Q0R RMA packaging: 6NG493ZB3SR-RMA-A100
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- * Advertised performance is based on maximum theoretical interface values from respective Chipset vendors or organization who defined the interface specification. Actual performance may vary by system configuration.
- * All trademarks and logos are the properties of their respective holders.
- * Due to standard PC architecture, a certain amount of memory is reserved for system usage and therefore the actual memory size is less than the stated amount.